#### **Overview**

#### HP ProBook 640 G3 Notebook PC



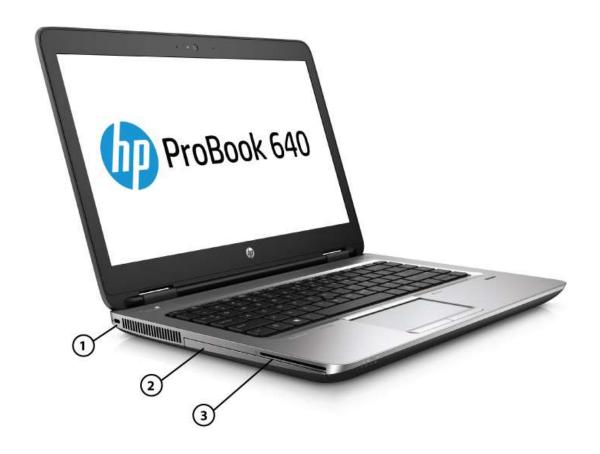
#### Front/Right

- 1. WLAN antennas (2)
- 2. WWAN antennas (2) (select models)
- 3. Internal microphones (2)
- 4. Webcam LED (select models)
- 5. Webcam (select models)
- 6. Wireless on/off button
- 7. Speaker mute button
- 8. Power connector
- 9. SIM card slot
- 10. Docking connector
- 11. Ethernet port
- 12. USB 3.0 ports (2)

- 13. SD card slot
- 14. DisplayPort™
- 15. USB-C<sup>™</sup> port
- 16. Microphone/ headphones combo jack
- 17. Fingerprint reader (select models)
- 18. Touchpad
- 19. Touchpad buttons
- 20. Indicator LEDs: Wireless Light, Power Light, AC Adapter/Battery Light, Storage Usage Light
- 21. NFC (select models)
- 22. Pointstick (select models)
- 23. Power button



### **Overview**



#### Left side

- 1. Security lock slot
- 2. Optical drive (select models)

3. Smart Card Reader



### **Overview**



Back

#### 1. VGA port



#### **Overview**

#### HP ProBook 650 G3 Notebook PC



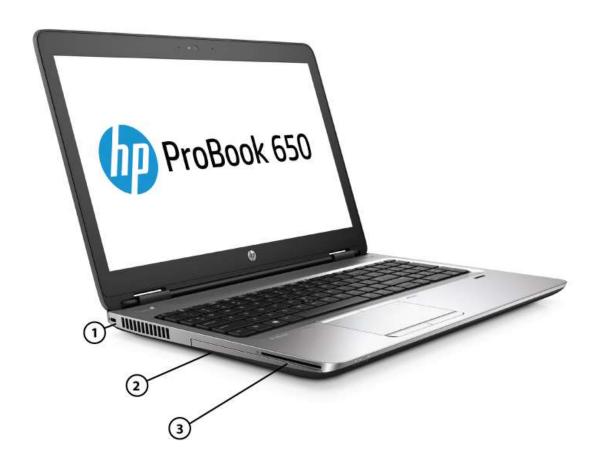
#### Front/Right

- 1. WLAN antennas (2)
- 2. WWAN antennas (2) (select models)
- 3. Internal microphones (2)
- 4. Webcam LED (select models)
- 5. Webcam (select models)
- 6. Wireless on/off button
- Speaker mute button
- 8. Power connector
- 9. SIM card slot
- 10. Docking connector
- 11. Ethernet port
- 12. USB 3.0 ports (2)

- 13. Numeric keypad
- 14. SD card slot
- 15. DisplayPort™
- 16. USB-C<sup>™</sup> port
- 17. Microphone/ headphones combo jack
- 18. Fingerprint reader (select models)
- 19. Touchpad
- 20. Touchpad buttons
- 21. Indicator LEDs: Wireless Light, Power Light, AC Adapter/Battery Light, Storage Usage Light
- 22. NFC (select models)
- 23. Pointstick
- 24. Power button



### **Overview**



#### Left side

- 1. Security lock slot
- 2. Optical drive (select models)

3. Smart card reader



### **Overview**



1. VGA port

2. Serial port optional



#### **Overview**

#### AT A GLANCE

- Windows 10 versions, NeoKylin Linux® 64 or FreeDOS 2.0
- Protect existing IT investment with optional optical drive and optional serial port (HP ProBook 650 G3 only)
- Choice of 7th Generation Intel® Core™ i3, i5, and i7 processors (including quad core on HP ProBook 650 G3)
- The HP Premium keyboard is spill-resistant and offered with optional backlit design
- Large Touchpad with gestures support, on/off button with LED indicator
- Enhanced security features including TPM 2.0, SmartCard Reader and optional Fingerprint reader
- LED-backlit display
  - HP ProBook 640: 35.56 cm (14") diagonal HD and FHD or Touch FHD with camera and with WWAN HP ProBook 650: 39.6 cm (15.6") diagonal HD and FHD or Touch FHD with camera and with WWAN
- Optional HD webcam with dual-microphone array for video conferencing
- DisplayPort<sup>™</sup> 1.2 with integrated graphics
- Three USB ports for fast data transfer from devices: one standard, one charging, and one USB-C™ charging port
- Wireless and speaker mute button to conveniently manage the connectivity and speaker.
- Flexible wireless connectivity options:
  - Broadband Wireless (WWAN)
  - Wireless LAN (WLAN)
  - Personal area network (WPAN Bluetooth®
  - Near Field Communication (NFC)
- Choice of hard drives up to 1 TB or solid state drives up to 512 GB
- Pending MIL STD testing

1. MIL STD 810G testing is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Damage under the MIL STD test conditions or any accidental damage requires an optional HP Accidental Damage Protection Care Pack.

**NOTE:** See important legal disclosures for all listed specs in their respective features sections.



## **Technical Specifications**

#### PRODUCT NAMES

HP ProBook 640 G3 Notebook PC HP ProBook 650 G3 Notebook PC

#### OPERATING SYSTEM

**Preinstalled** Windows 10 Pro 64<sup>1</sup>

Windows 10 Home 64<sup>1</sup> NeoKylin Linux 64 FreeDOS 2.0

**Web-only Support** Windows 10 Enterprise 64<sup>1</sup>

#### NOTE: Your product does not support Windows 8 or Windows 7

In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com.

Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately
purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is
automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time
for updates. See http://www.windows.com.

#### **PROCESSORS**

Intel® Core™ i3-7100U (2.4 GHz, 3 MB cache, 2 cores)₁

Intel® Core™ i5-7200U (2.5 GHz, up to 3.1 GHz with Intel Turbo Boost Technology, 3 MB cache, 2 cores)₁

Intel® Core™ i5-7300U (2.6 GHz, up to 3.5 GHz with Intel Turbo Boost Technology, 3 MB cache, 2 cores)₁

Intel® Core™ i5-7440HQ (2.8 GHz, up to 3.8 GHz with Intel Turbo Boost Technology, 6 MB cache, 4 cores) 1,2

Intel® Core™ i7-7600U (2.9 GHz, up to 3.9 GHz with Intel Turbo Boost Technology, 4 MB cache, 2 cores)₁

Intel® Core™ i7-7820HQ (2.9 GHz, up to 3.9 GHz with Intel Turbo Boost Technology, 8 MB cache, 4 cores) 1,2

#### **Processors Family**

7th Generation Intel® Core™ i3 processor (i3-7100U model)

7th Generation Intel® Core™ i5 processor (i5-7200U, i5-7300U, i5-7440HQ models)

7th Generation Intel® Core™ i7 processor (i7-7600U, i7-7820HQ models)

**Note:** In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com.



## **Technical Specifications**

Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.

- 1. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering is not a measurement of higher performance.
- 2. Available on HP ProBook 650 only.

#### **CHIPSET**

Integrated with processor

#### **GRAPHICS**

**HP ProBook 640** Integrated:

Intel® HD1 Graphics 620

#### Discrete:

AMD Radeon™ R7 M465 (2 GB GDDR5 dedicated memory)<sup>2</sup>

#### **HP ProBook 650** Integrated:

Intel® HD1 Graphics 620 Intel® HD1 Graphics 630

#### Discrete:

AMD Radeon™ R7 M465X (2 GB GDDR5 dedicated memory) 2

- 1. HD content required to view HD images.
- 2. AMD Dynamic Switchable Graphics technology requires an Intel® processor, plus an AMD Radeon™ discrete graphics configuration and is not available on FreeDOS and Linux OS. With AMD Dynamic Switchable Graphics technology, full enablement of all discrete graphics video and display features may not be supported on all systems (e.g. OpenGL applications will run on the integrated GPU or the APU as the case may be). Planned to be available in February 2016.

#### **DISPLAY**

#### **HP ProBook 640**

### Internal

Non-Touch

35.56 cm (14") diagonal LED-backlit HD1 SVA eDP Anti-glare Slim 45% CG 220 nits (1366x768)

35.56 cm (14") diagonal LED-backlit HD1 SVA eDP Anti-glare Slim 45% CG 220 nits (1366x768) with camera

35.56 cm (14") diagonal LED-backlit HD1 SVA eDP Anti-glare Slim 45% CG 220 nits (1366x768) with WWAN

35.56 cm (14") diagonal LED-backlit HD1 SVA eDP Anti-glare Slim 45% CG 220 nits (1366x768) with camera and with WWAN

35.56 cm (14") diagonal LED-backlit FHD SVA eDP Anti-glare Slim 60% CG 300 nits (1920x1080)



## **Technical Specifications**

35.56 cm (14") diagonal LED-backlit FHD SVA eDP Anti-glare Slim 60% CG 300 nits (1920x1080) with camera

35.56 cm (14") diagonal LED-backlit FHD SVA eDP Anti-glare Slim 60% CG 300 nits (1920x1080) with WWAN

35.56 cm (14") diagonal LED-backlit FHD SVA eDP Anti-glare Slim 60% CG 300 nits (1920x1080) with camera & WWAN

#### Touch

35.56 cm (14") diagonal LED-backlit FHD SVA eDP 60% CG 300 nits (1920x1080) with camera and with WWAN

#### **External**

Up to 32-bit per pixel color depth

#### VGA

Port supports resolutions up to 1920 x 1200 external resolution @60 Hz

#### DisplayPort<sup>™</sup> 1.2

Supports resolutions up to 2560  $\times$  1600, 30-bit color depth at 60 Hz, and full HD (1920  $\times$  1080) monitors, 24-bit color depth at 120 Hz

#### **Number of Displays Supported**

Supports 3 independent displays if used with optional HP Ultraslim Docking Station<sup>2</sup>

#### **HP ProBook 650**

#### Internal

#### Non-Touch

39.6 cm (15.6") diagonal LED-backlit HD1 SVA eDP Anti-glare Slim 45% CG 220 nits (1366 x 768)

39.6 cm (15.6") diagonal LED-backlit HD¹ SVA eDP Anti-glare Slim 45% CG 220 nits (1366 x 768) with camera

39.6 cm (15.6") diagonal LED-backlit HD¹ SVA eDP Anti-glare Slim 45% CG 220 nits (1366 x 768) with WWAN

39.6 cm (15.6") diagonal LED-backlit HD¹ SVA eDP Anti-glare Slim 45% CG 220 nits (1366 x 768) with camera and with WWAN

39.6 cm (15.6") diagonal LED-backlit FHD SVA eDP Anti-glare Slim 60% CG 300 nits (1920 x 1080)

39.6 cm (15.6") diagonal LED-backlit FHD SVA eDP Anti-glare Slim 60% CG 300 nits (1920 x 1080) with camera

39.6 cm (15.6") diagonal LED-backlit FHD SVA eDP Anti-glare Slim 60% CG 300 nits (1920 x 1080) with WWAN

39.6 cm (15.6") diagonal LED-backlit FHD SVA eDP Anti-glare Slim 60% CG 300 nits (1920 x 1080) with camera & WWAN

#### **Touch**

39.6 cm (15.6") diagonal LED-backlit FHD SVA eDP 60% CG 300 nits (1920 x 1080) with camera with WWAN

#### **External**

Up to 32-bit per pixel color depth

#### DisplayPort<sup>TM</sup> 1.2

Supports resolutions up to 2560  $\times$  1600, 30-bit color depth at 60 Hz, and full HD (1920  $\times$  1080) monitors, 24-bit color depth at 120 Hz

#### **VGA**

Port supports resolutions up to 1920 x 1200 external resolution @60 Hz

#### DisplayPort<sup>TM</sup> 1.2

Supports resolutions up to 2560  $\times$  1600, 30-bit color depth at 60 Hz, and full HD (1920  $\times$  1080) monitors, 24-bit color depth at 120 Hz

#### **Number of Displays Supported**

Supports 3 independent displays if used with optional HP Ultraslim Docking Station<sup>2</sup>

1. HD content required to view HD images.



## **Technical Specifications**

2. Sold separately or as an optional feature.

NOTE: Resolutions are dependent upon monitor capability, and resolution and color depth settings.

#### STORAGE AND DRIVES

#### **Primary Storage Bay**

#### SATA, 2.5" Hard Drives<sup>1</sup>

500 GB 7200 rpm 500 GB 7200 rpm Self-Encrypting Drive (Opal 2) 500 GB 7200 rpm Self Encrypting Drive (Opal 2) (FIPS-140-2) 1 TB 5400 rpm 500 GB 5400 rpm Hybrid

#### M.2 (NGFF) Solid State Drive1

128 GB SATA-3 SS Value
256 GB SATA-3 SS TLC (Opal 2)
256 GB PCIe Gen3x4 NVMe SS TLC
512 GB PCIe Gen3x4 NVMe SS TLC
512 GB SATA SS TLC (FIPS)
512 GB PCIe Gen3x4 NVMe SS TLC (Opal 2)
360 GB PCIe Gen3x4 NVMe SS Three Layer Cell
256 GB PCIe Gen3x4 NVMe SS Value
512 GB PCIe Gen3x4 NVMe SS Value

1. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB of system disk is reserved for system recovery software.

#### **OPTICAL DRIVES**

#### Fixed 9.5 mm SATA

DVD-ROM Drive DVD+/-RW SuperMulti DL1

- 1. Intended for your original content and other lawful uses. Don't copy copyright-protected materials. Note that DVD-RAM cannot read or write to 2.6GB Single Sided/5.2 GB Double Sided Version 1.0 media.
- 2. Not available on with Touch panel.

#### **MEMORY**

DDR4-2133 SDRAM (Transfer rates up to 1866 MT/s) Two SODIMM slots supporting dual-channel memory Both slots are customer accessible / upgradeable

#### **Configurations**

4096 MB Total System Memory (4096 MB x 1)



### HP ProBook 640 G3 Notebook PC HP ProBook 650 G3 Notebook PC

## QuickSpecs

## **Technical Specifications**

8192 MB Total System Memory (4096 MB x 2)

8192 MB Total System Memory (8192 MB x 1)

12288 MB Total System Memory (8192 MB + 4096 MB)

16384 MB Total System Memory (8192 MB x 2)

32768 MB Total System Memory (16384 MB x 2) (Planned to be available 2Q 17)

#### Maximum

Up to 16384 MB

Up to 32768 MB (Planned to be available 2Q 17)

#### **Dual-channel**

Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory slots.

**NOTE:** Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

#### **NETWORKING/COMMUNICATIONS**

#### Broadband Wireless (WWAN) 2,3

HP lt4120 Qualcomm® Snapdragon™ X5 LTE Mobile Broadband Module HP lt4132 LTE/HSPA+ 4G Mobile Broadband Module HP hs3210 HSPA+ Mobile Broadband Module

#### Wireless LAN (WLAN)1,2

Options via Minicard

Intel® Dual Band Wireless-AC 3168 802.11 a/b/g/n/ac (1x1) Wi-Fi® and Bluetooth® 4.2 Combo (non-vPro)

Realtek 802.11b/g/n (1x1) and Bluetooth® 4.0 Combo (non-vPro)

Intel® Dual Band Wireless-AC 8265 802.11a/b/g/n/ac (2x2) WiFi and Bluetooth® 4.2 Combo (non-vPro and vPro)

#### Personal area network (WPAN Bluetooth) 1,2

Bluetooth® 4.0 supported via Broadcom Realtek

Bluetooth® 4.2 supported via all supported Intel® WLAN modules

#### Near Field Communication (NFC) Optional<sup>2</sup>

HP Module with NXP NFC Controller NPC100

- 1. Wireless access point and Internet service is required and is not included. Availability of public wireless access points limited.
- 2. Sold separately or as an optional feature.
- 3. WWAN module requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

#### **Support for Miracast (Windows 10)**

Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming media players that also support Miracast. You can use Miracast to share what you're doing on your PC and present a slide show. For more information: http://windows.microsoft.com/en-us/windows-8/project-wireless-screen-miracast.

#### Communications<sup>1</sup>

Intel® I219LM 10/100/1000 Ethernet



## **Technical Specifications**

Intel® I219V 10/100/1000 Ethernet

1. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

#### **AUDIO/MULTIMEDIA**

#### **Audio**

(2) Integrated stereo speakers
Integrated digital microphone (Dual-microphone array when equipped with optional webcam)
Function keys for microphone mute, volume up, volume down
Stereo headphone/line out
Stereo microphone in

#### Webcam

Optional 720p HD webcam 1,2

- 1. Sold separately or as an optional feature.
- 2. HD content required to view HD images.

### **KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS**

#### **HP Premium Keyboard**

The HP spill-resistant keyboard is designed using a thin layer of Mylar film under the keyboard. The 101/102-key compatible keyboard features a full-pitch key layout with desktop keyboard features, such as editing keys, both left and right control and alt keys, and function keys. DuraKeys only available with Backlit option.

#### **Three Keyboard Options**

Touchpad, Spill-resistant with drain Touchpad, Spill-resistant with drain, DuraKeys & Backlit Dual Point, Spill-resistant with drain, DuraKeys & Backlit

#### Touchpad

On/Off button
Enabled by default
2F Scrolling – On
2F Zoom ( Pinch ) – On
OSD ( enable / disable ) – On
Win 8 2F tap = right click – On
Win 8 Edge Swipes – On



## **Technical Specifications**

#### **Buttons and Function Keys**

F1 – Sleep

F2 - Blank

F3 - Backlit

F4 - Display Switch

F5 - Brightness down

F6 - Brightness up

F7 - Blank

F8 - Volume down

F9 - Volume up

F10 - Mic Mute

F11 - Bank

F12 - Num lock

#### **SOFTWARE AND SECURITY**

## Preinstalled Software with Windows Operating System BIOS

HP BIOSphere1

HP DriveLock | HP Automatic DriveLock

**BIOS Update via Network** 

**Master Boot Record Security** 

Power On Authentication

Secure Erase<sup>2</sup>

Absolute Persistence Module<sup>3</sup>

**Pre-boot Authentication** 

#### Multi Media

CyberLink Power Media Player - CMIT

CyberLink Power2Go

#### **Communication / Connectivity**

HP Mobile Connect Pro (Windows 10 only)4

Native Miracast Support⁵

**HP LAN-WLAN Protection** 

**HP MAC Address Manager** 

#### **HP Value Add Software**

HP 3D DriveGuard<sup>10</sup>

HP ePrint Driver<sup>6</sup>

**HP Hotkey Support - CMIT** 

**HP Recovery Manager** 

**HP Jumpstart** 

**HP Support Assistant** 



## **Technical Specifications**

**HP Noise Cancellation Software** 

**HP Image Assistant** 

HP Workwise<sup>12</sup>

#### **Microsoft Products**

Buy Office Bing Search Skype<sup>7</sup>

#### Manageability

**HP Driver Packs<sup>8</sup>** 

HP SoftPaq Download Manager (SDM)

HP System Software Manager (SSM)8

HP BIOS Config Utility (BCU)8

HP Client Catalog8

HP MIK for Microsoft SCCM<sup>8</sup>

LANDESK Management9

For more information on HP Client Management Solutions refer to: http://www.hp.com/go/clientmanagement.

#### **Client Security Software**

**HP Client Security Suite Gen3** 

- HP Security Manager (including Credential Manager and Password Manager)
- HP Drive Lock
- HP Fingerprint Sensor
- HP Password Manager
- Absolute Persistence Module
- Power On Authentication

Microsoft Defender

#### Security

Trusted Platform Module (TPM) 2.0 (Infineon SLB9670). Common Criteria EAL4+ Certified.

Convertible to FIPS 140-2 Certified mode.

HP Fingerprint reader (On select models)

Security lock slot (Cable not included)

**Integrated Smart Card Reader** 

- 1 Available only on business PCs with HP BIOS.
- 2. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88.
- 3. Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: http://www.absolute.com/company/legal/agreements/ computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.



## **Technical Specifications**

- 4. HP Mobile Connect Pro is only available on preconfigured devices with WWAN. For geographic availability refer to <a href="https://www.hp.com/go/mobileconnect">www.hp.com/go/mobileconnect</a>
- 5. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming media players that also support Miracast. You can use Miracast to share what you're doing on your PC and present a slide show. For more information: http://windows.microsoft.com/en-us/windows-8/project-wireless-screen-miracast
- 6. Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see www.hp.com/qo/eprintcenter).
- 7. Skype is not offered in China.
- 8. Not preinstalled, however available for download at http://www.hp.com/go/clientmanagement
- 9. Subscription required.
- 10. Requires Windows.
- 11. This product ships with TPM 1.2 with option to upgrade to TPM 2.0. Upgrade utility is expected to be available via HP Customer Support.
- 12. HP Workwise smartphone app will soon be available as a free download on the App Store and Google Play.

#### **POWER**

#### Power Supply<sup>1</sup>

HP 45W Smart AC Adapter HP 45W Smart AC Adapter (2 prong) HP 65W Smart AC Adapter HP 65W Smart EM Adapter HP 90W Smart AC Adapter

1. Availability may vary by country.

#### **Power cord**

Power cord included is 1.8 m (+/-0.1 m) or 1.0 m (+/-0.1 m).

#### **Primary Battery**

HP 3-cell Long Life Prismatic (48 WHr)

**NOTE:** Battery is internal and not replaceable by customer.

#### Battery Life<sup>1</sup>

Platform	Other HW Details	Battery	UMA Graphics	Discrete Graphics
HP ProBook 640 G3	HDD	3-cell (48WHr)	Up to 10 hrs 30 mins	Up to 10 hrs 30 mins
HP ProBook 640 G3	SSD	3-cell (48WHr)	Up to 13 hrs 45 mins	Up to 13 hrs 15 mins
HP ProBook 650 G3	HDD	3-cell (48WHr)	Up to 10 hrs	Up to 10 hrs 30 mins
HP ProBook 650 G3	SSD	3-cell (48WHr)	Up to 13 hrs	Up to 13 hrs 15 mins



## **Technical Specifications**

#### System Standby Time<sup>2</sup>

**TBD** 

- 1. Windows 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.
- 2. Standby life will vary depending on various factors including battery, Memory, CPU, EC and LAN chip. The maximum capacity of the battery will naturally decrease with time and usage.

#### **WEIGHTS & DIMENSIONS**

#### HP ProBook 640 Notebook PC Weight

Starting at 4.30 lbs (1.95 kg)1

(3-cell battery, ODD weight saver, UMA, no FPR, 1 SODIMM, WLAN only, SSD, touchpad only, no camera, no WWAN)

#### **Dimensions** (w x d x h)

13.39 x 9.33 x 1.06 in (Front and rear)<sup>2</sup> 34.0 x 23.7 x 2.70 cm (Front and rear)<sup>2</sup>

#### HP ProBook 650 Notebook PC Weight

Starting at 5.10 lbs (2.31 kg)<sup>1</sup>

(3-cell battery, ODD weight saver, UMA, no FPR, 1 SODIMM, WLAN only, SSD, touchpad only, no camera, no WWAN)

#### **Dimensions** (w x d x h)

14.88 x 10.11 x 27.40 in (Front and rear)<sup>2</sup> 37.8 x 25.70 x 2.74 cm (Front and rear)<sup>2</sup>

- 1. Weight varies by configuration and components.
- 2. Height varies depending upon where on the notebook the measurement is made.

#### **PORTS/SLOTS**

#### Ports

1 USB Type-C™

1 USB 3.0 port

1 USB 3.0 port charging

1 RJ-45 / Ethernet

1 Docking connector

1 Headphone / Microphone (Combo jack)

1 AC port (4.5mm)

1 DisplayPort™ 1.2

1 VGA port

1 Optional Serial port (Only available on HP ProBook 650) 1

1. Sold separately or as an optional feature.

#### **SD Media Reader Slot**

Supports SD, SDHC, SDXC



## **Technical Specifications**

#### SERVICE AND SUPPORT

HP Services offers 3-year and 1-year limited warranties and 90 day software support options depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. On-site service and extended coverage is also available withHP Care Pack Services, optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc. 1,2

- 1. Sold separately or as an optional feature.
- 2. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc

BV

#### **DISPLAYS**

**Surface Treatment** 

**Note:** All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

Active Area (W x H) 309.40 x 173.95 (mm)

Dimensions (W x H) 320.9 x 205.6 (mm) max

Diagonal Size14 (inch)Thickness3.0 (mm) maxWeight430 g maxInterfaceeDP 1.2

Contrast Ratio 300:1 (typical)

Refresh Rate60 HzBrightness300 nits

Pixel Resolution - Format 1920 x 1080 (FHD)

PPI 157
Pixel Resolution - Configuration RGB
Backlight LED
Color Gamut Coverage 60%

Color Depth6 bits + Hi FRCViewing AngleSVA 45/45/25/35

Touch Enabled Optional

Touch Point Supported 10-point multi-touch

Other Features AS
Pen Enabled No



## **Technical Specifications**

14.0" FHD AG WLED SVA 60%cg 300nits eDP Slim

 Active Area (W x H)
 309.40 x 173.95 (mm)

 Dimensions (W x H)
 320.9 x 205.6 (mm) max

Diagonal Size14 (inch)Thickness3.0 (mm) maxWeight270 g maxInterfaceeDP 1.2Surface TreatmentAnti-Glare (AG)

Surface Treatment

Contrast Ratio

Anti-Glare (AG)

300:1 (typical)

Refresh Rate60 HzBrightness300 nitsPixel Resolution - Format112

**PPI** 1920 x 1080 (FHD)

Pixel Resolution - Configuration RGB
Backlight LED
Color Gamut Coverage 60%

Color Depth6 bits + Hi FRCViewing AngleSVA 45/45/25/35

Touch Enabled Optional

**Touch Point Supported** 10-point multi-touch

Other Features AS
Pen Enabled No

14.0" diagonal HD AG WLED SVA 45%cg 220nits eDP Slim

Active Area (W x H) 309.40 x 173.95 (mm)

Dimensions (W x H) 320.9 x 205.6 (mm) max

Diagonal Size14 (inch)Thickness3.0 (mm) maxWeight290 g maxInterfaceeDP 1.2Surface TreatmentAnti-Glare (AG)Contrast Ratio300:1 (typical)

Refresh Rate 60 Hz
Brightness 220 nits

Pixel Resolution - Format 112

**PPI** 1366 x 768 (HD)

Pixel Resolution - Configuration RGB

Backlight LED



## **Technical Specifications**

Color Gamut Coverage 45%

Color Depth6 bits + Hi FRCViewing AngleSVA 45/45/25/35

Touch Enabled Optional

**Touch Point Supported** 10-point multi-touch

Other Features AS
Pen Enabled No

15.6" diagonal FHD AG WLED SVA 60%cg 300nits eDP Slim

3.2mm Touch

 Active Area (W x H)
 344.2 x 193.5 (mm)

 Dimensions (W x H)
 360 x 224.3 (mm) max

Diagonal Size15.6 (inch)Thickness3.2 (mm) maxWeight360 g maxInterfaceeDP 1.2Surface TreatmentAnti-Glare (AG)

Contrast Ratio

Anti-Glare (AG)
400:1 (typical)

Refresh Rate60 HzBrightness300 nits

Pixel Resolution - Format 142

**PPI** 1920 x 1080 (FHD)

Pixel Resolution - Configuration RGB
Backlight LED

Color Gamut Coverage 60%

Color Depth 6 bits

Viewing Angle SVA 45/45/25/35

Touch Point Supported Optional

Other Features 10-point multi-touch

Pen Enabled AS

15.6" FHD AG WLED SVA 60%cg 300nits eDP Slim 3.2mm

Active Area (W x H) 344.2 x 193.5 (mm)

Dimensions (W x H) 360 x 224.3 (mm) max

Diagonal Size15.6 (inch)Thickness3.2 (mm) maxWeight360 g maxInterfaceeDP 1.2Surface TreatmentAnti-Glare (AG)

Surface Treatment Anti-Glare (AG)
Contrast Ratio 400:1 (typical)



## **Technical Specifications**

Refresh Rate60 HzBrightness300 nitsPixel Resolution - Format101

PPI 1920 x 1080 (FHD)

Pixel Resolution - ConfigurationRGBBacklightLEDColor Gamut Coverage60%

Color Depth 6 bits

Viewing AngleSVA 45/45/25/35Touch Point Supported10-point multi-touch

Other Features AS
Pen Enabled No

15.6" diagonal HD AG WLED SVA 45%cg 220nits eDP Slim

 Active Area (W x H)
 344.2 x 193.5 (mm)

 Dimensions (W x H)
 360 x 224.3 (mm) max

Diagonal Size15.6 (inch)Thickness3.2 (mm) maxWeight370 g maxInterfaceeDP 1.2Surface TreatmentAnti Claus (AC)

Surface TreatmentAnti-Glare (AG)Contrast Ratio300:1 (typical)

Refresh Rate60 HzBrightness220 nitsPixel Resolution - Format101

**PPI** 1366 x 768 (HD)

Pixel Resolution - Configuration RGB
Backlight LED
Color Gamut Coverage 45%

Color Depth6 bits + Hi FRCViewing AngleSVA 45/45/25/35

#### **STORAGE**

**HDD 500 GB 7200RPM 7mm SATA** 

Capacity 500GB

**Drive Weight** 0.20-0.21 lbs (92-95 g)

**Rotation Speed** 7200 rpm **Cache Buffer** Up to 32MB



## **Technical Specifications**

NAND Type/Size N/A
Height 7mm
Width 69.85mm

Interface ATA-8, SATA 3.0

Interface Transfer Rate 600 MB/s

Single Track 1.5-2 ms

Seek Time Average 11-13 ms

Maximum 18-22 ms

**Logical Blocks** 976,773,168

**Operating Temperature** 32° to 140° F (0° to 60° C) [top cover temp]

Security Features ATA Security

Other Features S.M.A.R.T., NCQ, Ultra DMA

#### HDD 500GB 7200RPM 7mm FIPS SATA Opal2

Capacity 500 GB

Drive Weight0.21 lbs (95 g)Rotation Speed7200 rpmCache Buffer32 MBNAND Type/SizeN/A

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85 mm)

 Interface
 ATA-8, SATA 3.0

Interface Transfer Rate 600 MB/s

Single Track 1.5 ms

Seek Time Average 12 ms

Maximum 21 ms

**Logical Blocks** 976,773,168

**Operating Temperature** 32° to 140° F (0° to 60° C) [top cover temp]

Security FeaturesATA Security; TCG Opal 2.x, FIPSOther FeaturesS.M.A.R.T., NCQ, Ultra DMA



## **Technical Specifications**

HDD 500GB 7200RPM 7mm SED SATA Opal2

Capacity 500 GB

Drive Weight0.21 lbs (95 g)Rotation Speed7200 rpmCache Buffer32 MBNAND Type/SizeN/A

 Height
 0.28 in (7 mm)

 Width
 2.75 in (69.85 mm)

 Interface
 ATA-8, SATA 3.0

Interface Transfer Rate 600 MB/s

Single Track 1.5 ms
Seek Time Average 12 ms
Maximum 21 ms

**Logical Blocks** 976,773,168

**Operating Temperature** 32° to 140° F (0° to 60° C) [top cover temp]

Security FeaturesATA Security; TCG Opal 2.xOther FeaturesS.M.A.R.T., NCQ, Ultra DMA

HDD 1TB 5400RPM 7mm SATA

Capacity 1TB

**Drive Weight** 0.198-0.21 lbs (90-95 g)

Rotation Speed 5400 rpm
Cache Buffer Up to 32MB

NAND Type/Size N/A
Height 7mm
Width 69.85mm

Interface ATA-8, SATA 3.0

Interface Transfer Rate 600 MB/s

Seek Time Single Track 1.5-2 ms
Average 12-13 ms
Maximum 18-32 ms

**Logical Blocks** 1,953,525,168

**Operating Temperature** 32° to 140° F (0° to 60° C) [top cover temp]

Security Features ATA Security

Other Features S.M.A.R.T., NCQ, Ultra DMA



## **Technical Specifications**

HDD 500 GB 5400RPM 7mm Hybrid SATA 8GB NAND

Capacity 500 GB

**Drive Weight** 0.20-0.21 lbs (92-95 q)

**Rotation Speed** 5400 rpm **Cache Buffer** Up to 64MB **NAND Type/Size** MLC/8GB Height 7mm Width 69.85mm Interface **ATA-8, SATA 3.0** 

**Interface Transfer Rate** 600 MB/s

**Seek Time** Average 12 ms Maximum 22 ms

**Logical Blocks** 976,773,168

**Operating Temperature** 32° to 140° F (0° to 60° C) [top cover temp]

Single Track

2 ms

**Security Features ATA Security** 

Other Features S.M.A.R.T., NCQ, Ultra DMA

SSD 128GB 2280 M2 SATA-3 Value

Form-Factor (I/O) M.2 2280 Capacity 128 GB **NAND Type** MLC/TLC

Weight 0.01-0.02 lb (6-10 g) Height 0.09 in (2.3 mm) Width 0.87 in (22 mm) Interface **ATA-8, SATA 3.0 Sequential Read** 520 ~ 535 MB/s 185 ~ 515 MB/s **Sequential Write** 

**Logical Blocks** 250,069,680

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

**Security Features** ATA Security (Option) Other Features DIPM; TRIM; DEVSLP

SSD 256GB 2280 M2 PCIe-3x4 SS NVMe TLC

Form-Factor (I/O) M.2 2280



## **Technical Specifications**

Capacity256 GBNAND TypeTLC

 Weight
 0.02 lb (10 g)

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 PCIe NVMe Gen3X4

 Sequential Read
 1,800 ~ 2,600 MB/s

 Sequential Write
 600 ~ 900 MB/s

**Logical Blocks** 500,118,192

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Security Features ATA Security (Option)

Other Features TRIM; L1.2

SSD 512GB 2280 M2 PCIe-3x4 SS NVMe TLC

Form-Factor (I/O) M.2 2280
Capacity 512 GB
NAND Type TLC

 Weight
 0.02 lb (10 g)

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 PCIe NVMe Gen3X4

 Sequential Read
 1,580 ~ 2,600 MB/s

 Sequential Write
 300 ~ 1400 MB/s

**Logical Blocks** 1,000,215,216

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Security Features ATA Security (Option)

Other Features TRIM; L1.2

SSD 256GB 2280 M2 SATA-3 Self Encrypted OPAL2 Three Layer Cell

Form-Factor (I/O) M.2 2280
Capacity 256 GB
NAND Type TLC

 Weight
 0.02 lb (10 g)

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 ATA-8, SATA 3.0

 Sequential Read
 515 ~ 530 MB/s

 Sequential Write
 490 ~ 515 MB/s

**Logical Blocks** 500,118,192



## **Technical Specifications**

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Security Features ATA Security; TCG Opal 2.0

Other Features DIPM; TRIM; DEVSLP

SSD 360GB 2280 PCle-3x4 NVMe Three Layer Cell

Form-Factor (I/O) M.2 2280
Capacity 360 GB
NAND Type TLC

 Weight
 0.02 lb (10 g)

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 PCle NVMe Gen3x4

Sequential Read1,700 MB/s (Compressible Performance)Sequential Write600 MB/s (Compressible Performance)

**Logical Blocks** 703,282,608

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Security Features ATA Security (Option)

Other Features TRIM; L1.2

SSD 512GB 2280 M2 SATA-3 Three Layer Cell Federal Information Processing Standard

Form-Factor (I/O) M.2 2280
Capacity 512 GB
NAND Type TLC

 Weight
 0.02 lb (10 g)

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 ACS-3, SATA 3.2

 Sequential Read
 530 MB/s

Sequential Write 400 MB/s
Logical Blocks 1,000,215,216

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Security Features ATA Security; TCG Opal 2.0; FIPS

Other Features DIPM; TRIM; DEVSLP

256 GB PCIe Gen3x4 NVMe SS Value Solid State Drive

Form-Factor (I/O) M.2 2280
Capacity 256 GB
NAND Type TLC

**Weight** 0.02 lb (10 g)



## **Technical Specifications**

Height 0.09 in (2.3 mm) Width 0.87 in (22 mm) Interface PCIe NVMe Gen3X4

**Sequential Read** 1,700 MB/s (Compressible Performance) **Sequential Write** 600 MB/s (Compressible Performance) **Logical Blocks** 500,118,192

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

**Security Features** ATA Security (Option)

**Other Features** TRIM; L1.2

512 GB PCIe Gen3x4 NVMe SS Value Solid State Drive

Form-Factor (I/O) M.2 2280 512 GB Capacity **NAND Type** TLC

Weight 0.02 lb (10 g) Height 0.09 in (2.3 mm) Width 0.87 in (22 mm) Interface PCIe NVMe Gen3X4

**Sequential Read** 1,700 MB/s (Compressible Performance) **Sequential Write** 600 MB/s (Compressible Performance) **Logical Blocks** 1000,215,216

32° to 158°F (0° to 70°C) [ambient temp] **Operating Temperature** 

**Security Features** ATA Security (Option)

**Other Features TRIM; L1.2** 

#### **OPTICAL DRIVES**

	Access Times	Random	<140ms CD (typical)
			< 160ms DVD (typical)
	Weight 150g max.		
		24X CD-ROM	
DVDROM Drive	Max Data Transfer Rate	8X DVD-ROM	
DVDNO! I DIVC		5X DVD-RAM	
		UDMA Mode 5	
	Interface	Gen 1 SATA	
	Supported Media (read)		TEXT, CD-ROM, CD-ROM XA, MIXED MODE -I Bridge (Photo-CD, Video CD),



## **Technical Specifications**

Multisession CD (Photo-CD, CD-EXTRA, Portfolio, CD-R, CD-RW), CD-R, CD-RW, DVD-ROM (DVD-5, DVD-9,

DVD-10, DVD-18), DVD-R, DVD-RW, DVD+R,

DVD+RW, DVD-RAM

**Max Media Capacity** 

(read)

8.5 GB

**Transport** Tray Loading

Access Times Random <140ms CD (typical)

< 160ms DVD (typical)

Weight 150g max.

24X CD-ROM 8X DVD-ROM 24X CD-R 10X CD-RW 8X DVD+R

Max Data Transfer Rate 8X DVD+RW

8X DVD-R 6X DVD-RW

6X - DVD+R Dual Layer 6X - DVD-R Dual Layer

DVD+/-RW SuperMulti DL Drive

5X DVD-RAM UDMA Mode 5

Interface Gen 1 SATA

CD-DA, CD-TEXT, CD-ROM, CD-ROM XA, MIXED MODE

CD, CD-I, CD-I Bridge (Photo-CD, Video CD),

Supported Media (read)

Multisession CD (Photo-CD, CD-EXTRA, Portfolio, CD-R, CD-RW), CD-R, CD-RW, DVD-ROM (DVD-5, DVD-9,

DVD-10, DVD-18), DVD-R, DVD-RW, DVD+R,

DVD+RW, DVD-RAM

Supported Media (write) CD-R, CD-RW, DVD+R, DVD+RW, DVD-R, DVD-RW,

DVD-RAM, DVD+R DL, DVD-R DL

**Max Media Capacity** 

**Transfer Mode** 

(read)

8.5 GB

**Max Media Capacity** 

(write)

8.5 GB

**Transport** Tray Loading

<200ms CD (typical)

Access Times Random <200ms DVD (typical)

<250ms BD (typical)

Weight 150g max.

Max Data Transfer Rate 24X CD-ROM



**BD** Drive

## **Technical Specifications**

8X DVD-ROM 6X BD-ROM 24X CD-R 10X CD-RW 8X DVD+R 8X DVD+RW 8X DVD-R

**6X DVD-RW** 

6X - DVD+R Dual Layer 6X - DVD-R Dual Layer

5X DVD-RAM 4X BD-R 2X BD-RE

Transfer Mode UDMA Mode 5
Interface Gen 1 SATA

CD-DA, CD-TEXT, CD-ROM, CD-ROM XA, MIXED MODE

CD, CD-I, CD-I Bridge (Photo-CD, Video CD),

**Supported Media** (read) Multisession CD (Photo-CD, CD-EXTRA, Portfolio, CD-R, CD-RW, DVD-ROM (DVD-5, DVD-9,

DVD-10, DVD-18), DVD-R, DVD-RW, DVD+R,
DVD+RW, DVD-RAM, BD-ROM, BD-R, BD-RE

**Supported Media** (write) CD-R, CD-RW, DVD+R, DVD+RW, DVD-R, DVD-RW, DVD-RAM, DVD+R DL, DVD-R DL, BD-R, BD-RE

Max Media Capacity

(read)

128 GB

**Max Media Capacity** 

(write)

128 GB

**Transport** Tray Loading



## **Technical Specifications**

#### **NETWORKING**

#### HP lt4120 Qualcomm® Snapdragon™ X5 LTE Mobile Broadband Module\*

**Technology/Operating bands** LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3),

1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8),

700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 17 lower),

800 (Band 20), 700 (Band 28).

HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4),

850 (Band 5), 900 (Band 8) MHz

EV-DO: 850 (BCO), 1900 (BC1) MHz (Only work with Verizon network)

E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 (Band 5), 900 (Band 8)

MHz

Wireless protocol standards 3GPP Release 10 LTE Specification CAT.4,

WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification

1xEVDO Release 0, A and B.

E-GPRS: Class B, Multi-slot class 12, coding schemes CS1 - CS4

and MSC1 - MSC9

GPS Standalone, A-GPS (MS-A, MS-B and XTRA)

**GPS bands** 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607 MHz

Maximum data rates LTE: 150 Mbps (Download), 50 Mbps (Upload)

DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload)

HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)

CDMA 1xRTT: 153.6 kbps (Download), 153.6 kbps (Upload)

EVDO Rel.A: 3.1 Mbps (Download), 1.8 Mbps (Upload)



## **Technical Specifications**

EVDO Rel.B: 14.7 Mbps (Download), 5.4Mbps (Upload)

EDGE: 236.8 kbps (Download), 236.8 kbps (Upload)

GPRS: 85.6 kbps(Download), 85.6 kbps (Upload)

Maximum output power LTE: 23 dBm

HSPA+: 23.5 dBm

1xRTT/EVD0: 24dBm

E-GPRS 1900/1800: 26 dBm

E-GPRS 900/850: 27 dBm

GPRS 1900/1800: 29.5 dBm

GPRS 900/850: 32.5 dBm

Maximum power consumption LTE: 1,200 mA (peak); 900 mA (average)

HSPA+: 1,100 mA (peak); 800 mA (average)

1xRTT/EVDO: 1,000 mA (peak); 700 mA (average)

E-GPRS: 2,800 mA (peak); 500 mA (average)

Form Factor M.2, 3042-S3 Key B

Weight 6.2 g

**Dimensions** 42 x 30 x 2.3 mm

(Length x Width x Thickness)

#### HP lt4132 LTE/HSPA+ 4G Mobile Broadband Module

Technology/Operating bands LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3) MHz,

850 (Band 5), 2600 (Band 7), 900 (Band 8) MHz,

800 (Band 20), 700 (Band 28) MHz.



<sup>\*</sup> Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in a provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, an not available on all products or in all countries.

## **Technical Specifications**

HSPA+: 2100 (Band 1), 1900 (Band 2), 850 (Band 5), 900 (Band 8) MHz

E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 (Band 5), 900 (Band 8) MHz

Wireless protocol standards 3GPP Release 10 LTE Specification CAT.4,

WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification

E-GPRS: Class B, Multi-slot class 12, coding schemes CS1 - CS4

and MSC1 - MSC9

**GPS** Standalone, A-GPS (MS-B and LTO)

**GPS bands** 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz

Maximum data rates LTE: 150 Mbps (Download), 50 Mbps (Upload)

DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload)

HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)

EDGE: 236.8 kbps (Download), 236.8 kbps (Upload)

GPRS: 85.6 kbps(Download), 85.6 kbps (Upload)

Maximum output power LTE: 23 dBm

HSPA+: 23.5 dBm

E-GPRS 1900/1800: 26 dBm

E-GPRS 900/850: 27 dBm

GPRS 1900/1800: 29.5 dBm

GPRS 900/850: 32.5 dBm

Maximum power consumption LTE: 1,200 mA (peak); 900 mA (average)

HSPA+: 1,100 mA (peak); 800 mA (average)

E-GPRS: 2,600 mA (peak); 500 mA (average)

Form Factor M.2, 3042-S3 Key B

Weight 6 g

**Dimensions** 42 x 30 x 2.3 mm

(Length x Width x Thickness)



## **Technical Specifications**

\* Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in a provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, a not available on all products or in all countries.

#### HP hs3210 HSPA+ Mobile Broadband Module\*

**Technology/Operating bands** HSPA+: 2100 (Band1), 1900 (Band 2), 850 (Band 5), 900 (Band 8) MHz

E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 MHz (Band 5), 900 (Band 8) MHz

Wireless protocol standards WCDMA R99, 3GPP Release 5, 6 and 7 UMTS Specification

E-GPRS: Class B, Multi-slot class 33, coding schemes CS1 - CS4 and MSC1 - MSC9

Maximum data rates HSPA+: 21.6 Mbps (Download), 5.76 Mbps (Upload)

E-GPRS: 296 kbps (Download), 236.8 kbps (Upload)

GPRS: 107 kbps (Download), 85.6 kbps (Upload)

Maximum output power HSPA+: 24

E-GPRS 1800/1900: 26 dBm E-GPRS 850/900: 27 dBm GPRS 1800/1900: 30 dBm

GPRS 850/900: 33 dBm

Maximum power consumption HSPA+: 1,100 mA (peak); 800 mA (average)

E-GPRS: 2,800 mA (peak); 700 mA (average)

Form Factor M.2, 2242-S3 Key B

Weight 6 g

**Dimensions** 1.65 x 8.66 x 0.09 in (42 x 22 x 2.38 mm)

(Length x Width x Thickness)



dBm

<sup>\*</sup> Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors.

## **Technical Specifications**

#### Intel® Dual Band Wireless-AC 3168 802.11 a/b/g/n/ac (1x1) Wi-Fi® and Bluetooth® 4.2 Combo

Wireless LAN Standards IEEE 802.11a

IEEE 802.11b IEEE 802.11g

IEEE 802.11n

IEEE 802.11ac

Interoperability Wi-Fi certified

Frequency Band 802.11b/g/n

• 2.402 – 2.482 GHz

Note:

The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

#### 802.11a/n

- 4.9 4.95 GHz (Japan)
- 5.15 5.25 GHz
- 5.25 5.35 GHz
- 5.47 5.725 GHz
- 5.825 5.850 GHz

Note:

Indonesia only supports 5.725 - 5.825 GHz (CH149 - CH161)

#### **Data Rates**

- 802.11b: 1, 2, 5.5, 11 Mbps
- 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
- 802.11ac: MCS0 ~ MCS9, (1SS) (20MHz, 40MHz, and 80MHz)

#### **Modulation** Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM



## **Technical Specifications**

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•	CU		ıty

- IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only
- AES-CCMP: 128 bit in hardware
- 802.1x authentication
- WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
- WPA2 certification
- IEEE 802.11i
- Cisco Certified Extensions, all versions through CCX4 and CCX
   Lite
- WAPI

Network Architecture Models Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming

IEEE 802.11 compliant roaming between access points

**Output Power<sup>2</sup>** 

- 802.11b: +16dBm minimum
   802.11g: +14dBm minimum
- 802.11a: +14dBm minimum
- 802.11n HT20(2.4GHz): +14dBm minimum
   802.11n HT40(2.4GHz): +12dBm minimum
   802.11n HT20(5GHz): +14dBm minimum
   802.11n HT40(5GHz): +12dBm minimum
- 802.11ac 80MHz(5GHz): +11dBm minimum

**Power Consumption** 

Transmit: 2.0 W (max)

Receive: 1.6 W (max)

Idle mode (PSP): 180 mW (WLAN Associated)

Idle mode: 50 mW (WLAN unassociated)

Connect Standby: 10 mW (WLAN+BT)

Radio disabled: 5 mW

**Power Management** 

ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity<sup>3</sup>

802.11b, 1Mbps : -94dBm maximum

802.11b, 11Mbps : -86dBm maximum

802.11g, 6Mbps : -88dBm maximum

802.11g, 54Mbps: -74dBm maximum

802.11a, 6Mbps: -88dBm maximum



## **Technical Specifications**

802.11a, 54Mbps: -74dBm maximum

802.11n, MCS07: -69dBm maximum

802.11n, MCS15: -66dBm maximum

802.11ac, 1SS, MCS-0: -86dBm maximum

802.11ac, 1SS, MCS-9: -61dBm maximum

802.11ac, 2SS, MCS-0: -83dBm maximum

802.11ac, 2SS, MCS-9: -58dBm maximum

**Antenna type** High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

**Dimensions** Type 2230 : 2.3 x 22.0 x 30.0 mm

0r

Type 1630: 2.3 x 16.0 x 30.0 mm

Weight Type 2230 : 2.8g

0r

Type 1630: 2g

Operating Voltage 3.3v +/- 9%

**Temperature** Operating 14° to 158° F (–10° to 70° C)

Non-operating  $-40^{\circ}$  to  $176^{\circ}$  F ( $-40^{\circ}$  to  $80^{\circ}$  C)

**Humidity** Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

**Altitude** Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF; LED White – Radio ON

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).



### **Technical Specifications**

HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

**Bluetooth Specification** 4.0/4.1/4.2 Compliant

Frequency Band 2402 to 2480 MHz

**Number of Available Channels** Legacy : 0~79 (1 MHz/CH)

BLE: 0~39 (2 MHz/CH)

**Data Rates and Throughput** Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps

BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

**Transmit Power** The Bluetooth component shall operate as a Class II Bluetooth device

with a maximum transmit power of + 4 dBm for BR and EDR.

**Receiver Sensitivity** 

Legacy

Modulation	0.01% BER	0.001% BER
GFSK	-80 dBm	-70 dBm
π/4-DQPSK	-80 dBm	-70 dBm
8DPSK	-80 dBm	-70 dBm

**Power Consumption** Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Range Legacy Up to 33 ft (10 m)

BLE Up to 99 ft (30 m)

Electrical Interface USB 2.0 compliant

**Bluetooth Software Supported** Microsoft Windows Bluetooth Software

**Link Topology** 



### **Technical Specifications**

**Electrical Interface** Point to Point, Multipoint Pico Nets up to 7 slaves

**Bluetooth Software Supported** Full support of Bluetooth Security Provisions

Security

**Power Management** Microsoft Windows ACPI, and USB Bus Support

Certifications Self-configurable to optimize power conservation in all operating

modes, including Standby, Hold, Park, and Sniff

Security All necessary regulatory approvals for supported countries, including:

Certifications FCC (47 CFR) Part 15C, Section 15.247 & 15.249

**Bluetooth Profiles Supported** 

ETS 300 328, ETS 300 826 **Power Management** 

Certifications Low Voltage Directive IEC950

UL, CSA, and CE Mark

Serial Port Profile (SPP)1.2

Service Discovery Application Profile (SDAP)

Dial-Up Networking (DUN)1.1

Generic Object Exchange Profile (GOEP)1,2

Object Push Profile (OPP)1,2

Hard Copy Cable Replacement (HCRP)<sup>1,2</sup> Personal Area Networking Profile (PAN)1.0 **Bluetooth Profiles Supported** 

Human Interface Device Profile (HID)1.0

Hands Free Profile (HFP) 1.5/1.6

Advanced Audio Distribution Profile (A2DP) 1.3

Audio Video Remote Control Profile (AVRCP) 1.3/1.4

Bluetooth V4.1/V4.2 support

feature

Certifications

V4.1: ESR5/6/7 compliant

V4.2: ESR8 compliant, LE Secure Connection – Basic.

Realtek 802.11b/g/n (1x1) and Bluetooth® 4.0 Combo



### **Technical Specifications**

Wireless LAN Standards IEEE 802.11a

IEEE 802.11b IEEE 802.11g

IEEE 802.11n

IEEE 802.11ac

Interoperability Wi-Fi certified

Frequency Band 802.11b/g/n

2.402 – 2.482 GHz

Note:

The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

#### 802.11a/n

- 4.9 4.95 GHz (Japan)
- 5.15 5.25 GHz
- 5.25 5.35 GHz
- 5.47 5.725 GHz
- 5.825 5.850 GHz

Note:

Indonesia only supports 5.725 - 5.825 GHz (CH149 - CH161)

#### **Data Rates**

- 802.11b: 1, 2, 5.5, 11 Mbps
- 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
- 802.11ac: MCS0 ~ MCS9, (1SS) (20MHz, 40MHz, and 80MHz)

#### **Modulation** Dire

Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

#### Security<sup>1</sup>

- IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only
- AES-CCMP: 128 bit in hardware
- 802.1x authentication
- WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.



### **Technical Specifications**

- WPA2 certification
- IEEE 802.11i
- Cisco Certified Extensions, all versions through CCX4 and CCX
   Lite
- WAPI

**Network Architecture** 

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

**Roaming** IEEE 802.11 compliant roaming between access points

Output Power<sup>2</sup> • 802.11b: +16dBm minimum

802.11g: +14dBm minimum
802.11a: +14dBm minimum

802.11n HT20(2.4GHz): +14dBm minimum
 802.11n HT40(2.4GHz): +12dBm minimum
 802.11n HT20(5GHz): +14dBm minimum
 802.11n HT40(5GHz): +12dBm minimum

802.11ac 80MHz(5GHz): +11dBm minimum

**Power Consumption** Transmit: 2.0 W (max)

Receive: 1.6 W (max)

Idle mode (PSP): 180 mW (WLAN Associated)

Idle mode: 50 mW (WLAN unassociated)

Connect Standby: 10 mW (WLAN+BT)

Radio disabled: 5 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

**Receiver Sensitivity<sup>3</sup>** 802.11b, 1Mbps: -94dBm maximum

802.11b, 11Mbps: -86dBm maximum

802.11g, 6Mbps: -88dBm maximum

802.11g, 54Mbps: -74dBm maximum

802.11a, 6Mbps : -88dBm maximum

802.11a, 54Mbps : -74dBm maximum

802.11n, MCS07 : -69dBm maximum

802.11n, MCS15: -66dBm maximum



### **Technical Specifications**

802.11ac, 1SS, MCS-0: -86dBm maximum

802.11ac, 1SS, MCS-9: -61dBm maximum

802.11ac, 2SS, MCS-0: -83dBm maximum

802.11ac, 2SS, MCS-9: -58dBm maximum

**Antenna type** High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

**Dimensions** Type 2230 : 2.3 x 22.0 x 30.0 mm

0r

Type 1630: 2.3 x 16.0 x 30.0 mm

Weight Type 2230: 2.8g

0r

Type 1630 : 2g

Operating Voltage 3.3v +/- 9%

**Temperature** Operating 14° to 158° F (–10° to 70° C)

Non-operating  $-40^{\circ}$  to  $176^{\circ}$  F ( $-40^{\circ}$  to  $80^{\circ}$  C)

**Humidity** Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

**Altitude** Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF; LED White – Radio ON

4. Check latest software/driver release for updates on supported security features.

5. Maximum output power may vary by country according to local regulations.

6. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

#### HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

**Bluetooth Specification** 4.0/4.1/4.2 Compliant



### **Technical Specifications**

Frequency Band 2402 to 2480 MHz

Number of Available Channels Legacy: 0~79 (1 MHz/CH)

BLE: 0~39 (2 MHz/CH)

**Data Rates and Throughput** Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps

BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device

with a maximum transmit power of + 4 dBm for BR and EDR.

**Receiver Sensitivity** 

Legacy

Modulation	0.01% BER	0.001% BER
GFSK	-80 dBm	-70 dBm
π/4-DQPSK	-80 dBm	-70 dBm
8DPSK	-80 dBm	-70 dBm

**Power Consumption** Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Range Legacy Up to 33 ft (10 m)

BLE Up to 99 ft (30 m)

Electrical Interface USB 2.0 compliant

**Bluetooth Software Supported** Microsoft Windows Bluetooth Software

**Link Topology** 

**Electrical Interface** Point to Point, Multipoint Pico Nets up to 7 slaves

**Bluetooth Software Supported** Full support of Bluetooth Security Provisions



### **Technical Specifications**

Security

**Power Management** Microsoft Windows ACPI, and USB Bus Support

Certifications Self-configurable to optimize power conservation in all operating

modes, including Standby, Hold, Park, and Sniff

Security All necessary regulatory approvals for supported countries, including:

Certifications FCC (47 CFR) Part 15C, Section 15.247 & 15.249

**Bluetooth Profiles Supported** 

**Power Management** ETS 300 328, ETS 300 826

**Certifications** Low Voltage Directive IEC950

UL, CSA, and CE Mark

Serial Port Profile (SPP)1.2

Service Discovery Application Profile (SDAP)

Dial-Up Networking (DUN)1.1

Generic Object Exchange Profile (GOEP)<sup>1,2</sup>

Object Push Profile (OPP)1,2

Hard Copy Cable Replacement (HCRP)<sup>1,2</sup> Personal Area Networking Profile (PAN)1.0 **Bluetooth Profiles Supported** 

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Hands Free Profile (HFP) 1.5/1.6

Advanced Audio Distribution Profile (A2DP) 1.3

Audio Video Remote Control Profile (AVRCP) 1.3/1.4

Bluetooth V4.1/V4.2 support

feature

Certifications

V4.1: ESR5/6/7 compliant

V4.2: ESR8 compliant, LE Secure Connection – Basic.

Intel® Dual Band Wireless-AC 7265 802.11a/b/g/n/ac (2x2) WiFi and Bluetooth® 4.2 Combo



### **Technical Specifications**

Wireless LAN Standards IEEE 802.11a

IEEE 802.11b IEEE 802.11g

IEEE 802.11n

IEEE 802.11ac

**Interoperability** Wi-Fi certified

Frequency Band 802.11b/g/n

• 2.402 - 2.482 GHz

Note:

The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

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- 4.9 4.95 GHz (Japan)
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- 5.47 5.725 GHz
- 5.825 5.850 GHz

Note: Indonesia no support this band)

#### **Data Rates**

- 802.11b: 1, 2, 5.5, 11 Mbps
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- 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
- 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)

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BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

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- WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
- WPA2 certification
- IEEE 802.11i



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WAPI

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802.11g: +14dBm minimum802.11a: +14dBm minimum

802.11n HT20(2.4GHz): +14dBm minimum
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Idle mode: 50 mW (WLAN unassociated)

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**Power Management** ACPI and PCI Express compliant power management

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**Receiver Sensitivity<sup>3</sup>** 802.11b, 1Mbps: -94dBm maximum

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802.11n, MCS15: -66dBm maximum

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802.11ac, 1SS, MCS-9: -61dBm maximum

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Weight Type 2230 : 2.8g

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Type 1630: 2g

Operating Voltage 3.3v +/- 9%

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Non-operating -40° to 176° F (-40° to 80° C)

**Humidity** Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

**Altitude** Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

**LED Activity** LED Amber – Radio OFF; LED White – Radio ON

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Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

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Electrical Interface USB 2.0 compliant

**Bluetooth Software Supported** Microsoft Windows Bluetooth Software

**Link Topology** 

**Electrical Interface** Point to Point, Multipoint Pico Nets up to 7 slaves

**Bluetooth Software Supported** Full support of Bluetooth Security Provisions

Security

**Power Management** Microsoft Windows ACPI, and USB Bus Support



**Technical Specifications** 

**Certifications** Self-configurable to optimize power conservation in all operating

modes, including Standby, Hold, Park, and Sniff

**Security** All necessary regulatory approvals for supported countries, including:

**Certifications** FCC (47 CFR) Part 15C, Section 15.247 & 15.249

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Power Management ETS 300 328, ETS 300 826

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Generic Object Exchange Profile (GOEP)<sup>1,2</sup>

Object Push Profile (OPP)1,2

Certifications Hard Copy Cable Replacement (HCRP)<sup>1,2</sup>

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Audio Video Remote Control Profile (AVRCP) 1.3/1.4

Bluetooth V4.1/V4.2 support

feature

V4.1: ESR5/6/7 compliant

V4.2: ESR8 compliant, LE Secure Connection – Basic.

**POWER** 

45 W AC Adaptor



### **Technical Specifications**

 Dimensions
 95.0x40.0x26.5mm

 Weight
 unit: 200g +/- 10g

**Input Efficiency** 87.74 % at 115 Vac and 88.4 % at 230 Vac

Input Input Frequency Range 47 ~ 63 Hz

Input AC current Max. 1.4 A at 90 Vac

Output Power45WDC Output19.5V

Output Hold-up Time 5ms at 115 Vac input

Output Over Current Protection <8.0A

DC Plug 4.5mm Barrel Type

**Operating Temperature** 32°F to 95°F (0°to 35°C)

Non-operating (storage) Temperature -4°F to 185°F (-20°to 85°C)

Environmental Design
Altitude 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

\*CE Mark - full compliance with LVD and EMC directives \* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22

Class B, CCC, NOM-1 NYCE.

\* MTBF - over 200,000 hours at 25°C ambient condition.

45 W 2 Prong AC Adaptor

**EMI and Safety Certifications** 

 Dimensions
 95.0x40.0x26.5mm

 Weight
 unit: 200g +/- 10g

Input Efficiency 87.74 % at 115 Vac and 88.4 % at 230 Vac

Input Input Frequency Range 47 ~ 63 Hz

**Input AC current** Max. 1.4 A at 90 Vac

Output Power45WDC Output19.5V

Output Hold-up Time 5ms at 115 Vac input

Output Over Current Protection <8.0A

DC Plug 4.5mm Barrel Type

**Operating Temperature** 32°F to 95°F (0°to 35°C)

Environmental Design Non-operating (storage) Temperature -4°F to 185°F (-20°to 85°C)

**Altitude** 0 to 16,400 ft (0 to 5000m)



### **Technical Specifications**

**EMI and Safety Certifications** 

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

\*CE Mark - full compliance with LVD and EMC directives

\* Worldwide safety standards - IEC60950, EN60950. UL60950, Class2, SELV; Agency approvals - C-UL-US, PSE

\* MTBF - over 200,000 hours at 25°C ambient condition.

65 W AC Adaptor

**Dimensions** 107.0x47.0x30.0mm Weight unit: 250g +/- 10g

> **Input Efficiency** 88.0 % at 115 Vac and 89.0 % at 230Vac

Input **Input Frequency Range** 47 ~ 63 Hz

> Input AC current Max. 1.7 A at 90 Vac

**Output Power** 65W **DC Output** 19.5V

**Output Hold-up Time** 5ms at 115 Vac input

> **Output Over Current Protection** <11.0A

DC Plug 4.5mm Barrel Type

> **Operating Temperature** 32°F to 95°F (0°to 35°C)

Non-operating (storage) Temperature -4°F to 185°F (-20°to 85°C)

**Environmental Design** 

**Altitude** 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

> \*CE Mark - full compliance with LVD and EMC directives \* Worldwide safety standards - IEC60950, EN60950,

UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22

Class B, CCC, NOM-1 NYCE.

\* MTBF - over 200.000 hours at 25°C ambient condition.

65 W EM AC Adaptor

**EMI and Safety Certifications** 

**Dimensions** 102.0x55.0x30.0mm Weight unit: 350g +/- 10g

**Input Efficiency** 87.0 % at 115 Vac and 230Vac Input

**Input Frequency Range** 47 ~ 63 Hz



### **Technical Specifications**

**Input AC current** Max. 1.7 A at 90 Vac

**Output Power** 65W **DC Output** 19.5V

Output Hold-up Time 5ms at 115 Vac input

Output Over Current Protection <11.0A

DC Plug 4.5mm Barrel Type

**Operating Temperature** 32°F to 95°F (0°to 35°C)

**Non-operating (storage) Temperature** -4°F to 185°F (-20°to 85°C)

Environmental Design
Altitude 0 to 16,400 ft (0 to 5000m)

Humidity20% to 95%Storage Humidity10% to 95%

\*CE Mark - full compliance with LVD and EMC directives \* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22

Class B, CCC, NOM-1 NYCE.

\* MTBF - over 200,000 hours at 25°C ambient condition.

90 W AC Adaptor

**EMI and Safety Certifications** 

 Dimensions
 127.0x51.0x30.0mm

 Weight
 unit: 350g +/- 10g

**Input Efficiency** 88% min at 115V and 89% min at 230V

Input Input Frequency Range 47 ~ 63 Hz

**Input AC current** 1.5 A at 90 VAC and maximum load

Output Power90WDC Output19.5V

Output Hold-up Time 5.50 Sms at 115 Vac input

Output Over Current Protection <11.0A

**DC Plug** 4.5mm Barrel Type

**Operating Temperature** 32°Fto 95°F (0°to 35°C)

Non-operating (storage) Temperature

Environmental Design

Altitude

-4°Fto 185°F (-20°to 85°C)

0 to 16,400 ft (0 to 5000m)

Humidity5% to 95%Storage Humidity5% to 95%



### **Technical Specifications**

**EMI and Safety Certifications** 

\*CE Mark - full compliance with LVD and EMC directives \* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22

Class B, CCC, NOM-1 NYCE.

\* MTBF - over 100,000 hours at 25°C ambient condition.

HP 3-cell, Long Life 48 WHr Li-ion

**Dimensions** (H x W x L)

15.05. x177.55x94.55 mm

Weight 0.25 kg (0.55lb)
Cells/Type 3cell Lithium-Ion

Voltage 11.4V/ 10.95V

**Energy** Amp-hour capacity 4.212Ah /4.385Ah

Watt-hour capacity 48Wh

Operating (Charging) 32° to 113° F (0° to 45° C)
Operating (Discharging) 14° to 122° F(-10° to 60°

operating (bischarging)

Non-operating

-4° to 122° F (-20° to 60°

C)

Battery Re-Charge Time System in OFF or Standby

Mode

<3 hours

Fuel Gauge LED No

Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the

platform.

**Optional Travel Battery** 

Available

Warranty

**Temperature** 

No

#### SECURITY

**HP Fingerprint Reader** (optional)

Mobile Voltage Operation

3.0V-3.6V

**Operating Temperature** 14° – 167°F (-10° – 75°C) **Current consumption** Imaging: 36 mA (typical)

Low latency wakeup: 950 µA (typical)

USB Suspend: 220 µA (max)

**ESD Resistance** IEC 61000-4-2 Level 4B (±15KV)



### **Technical Specifications**

**Detection Matrix** 508 DPI resolution, 256 levels of grayscale 200 pixel wide fingerprint image (10mm)

16.5mm x 3 mm (sensor area)

Smart Card Reader Smart card standard PC/SC 2.0 for Windows smart card standard

**Dimensions** (L x W x H) 0.41x 0.08 x 0.32 in (10.5 x 2 x 8.2 mm)

Smart Card support ISO 7816 Class A, B, and C (5V/3V/1.8V) card

**Smart Card Interface** Smart Card Interface with T = 0 and T = 1 support

Support I2C memory card, SLE4418, SLE4428, SLE4432, SLE4442, SLE4436, SLE5536, SLE6636, AT88SC1608, AT45D041 card and AT45DB041 card via

external EEPROM

**Operating systems** No driver is required for this device. Native support is provided by the operating

system.

Power Normal Mode With card present, before being suspended: 40.9 mA

Without card present, before being suspended: 33.16 mA After being suspended with smart card present: 380 µA After being suspended without smart card present: 380 µA

**Power Saving** With card present, before being suspended: 40.6 mA

**Mode** Without card present: 380 μA

After being suspended with smart card present: 380 µA

Features • Support single slot

• Support TO, T1 protocol

 Support I2C memory card, SLE4418, SLE4428, SLE4432, SLE4442, SLE4436,

 SLE5536, SLE6636, AT88SC1608, AT45D041 card and AT45DB041 card via external EEPROM

Support ISO7816 Class A, B and C (5V/3V/1.8V) card

 Implemented as an USB full speed device with bulk transfer endpoint, Mass

Storage endpoint

Built-in PLL for USB and Smart Card clocks requirement

 Support EEPROM for USB descriptors customization (PID/VID/ iManufacturer/iProduct/Serial Number), Direct Web Page Link, and accessing memory card module.

EEPROM programmable via USB interface

Support software update for memory card module

Support Direct Web Page Link via configuration in external EEPROM

Support short APDU and extended APDU

Compatible with Microsoft USB-CCID driver

Support remote wake up through inserting card/removing card

Support USB selective suspend



## **Technical Specifications**

- Support Power Saving Mode (Using one pin to select between Normal/PWR Saving Mode)
- Support card power over current protection mechanism
- Built in resonator.
- Support USB LPM (Link Power Management) features.
- Embedded clock source.

#### **ENVIRONMENTAL**

#### HP ProBook 640 G3 Notebook PC

Eco-Label	This product has received or is in the process of being certified to the following approvals and may						
Certifications &	be labeled with one or more of these marks:						
declarations	<ul> <li>IT ECO declaration</li> <li>US ENERGY STAR®</li> <li>EPEAT <gold> registered in the United States. See http://www.epeat.net for registration status in your country.</gold></li> </ul>						
System Configuration			n and Declared Noise Emissions data for the				
	Notebook model is based o	n a "Typically Configured I	Notebook".				
Energy Consumption (in accordance with US ENERGY STAR® test method)	115VAC, 60Hz 230VAC, 50Hz 100VAC, 50Hz						
Normal Operation (Short idle)	5.53 W	5.95 W	5.53 W				
Normal Operation (Long idle)	3.47 W	3.71 W	3.56 W				
Sleep	0.53 W	0.58 W	0.53 W				
Off	0.36 W	0.41 W	0.36 W				
	family. HP computers mark Environmental Protection family does not offer ENER	ked with the ENERGY STAF Agency (EPA) ENERGY ST GY STAR® compliant confi PC featuring a hard disk	compliant product if offered within the model R® Logo are compliant with the applicable U.S. AR® specifications for computers. If a model gurations, then energy efficiency data listed is drive, a high efficiency power supply, and a				



Heat Dissipation*	115VAC, 60Hz 230VAC, 50Hz		50Hz	100VAC, 50Hz				
Normal Operation (Short idle)	19 BTU/hr	20 BTU/hr		20 BTU/hr		20 BTU/hr		19 BTU/hr
Normal Operation (Long idle)	12 BTU/hr	13 BTU/hr		13 BTU/hr		13 BTU/hr		12 BTU/hr
Sleep	2 BTU/hr	2 BTU	/hr	2 BTU/hr				
Off	1 BTU/hr	1 BTU	/hr	1 BTU/hr				
	*NOTE: Heat dissipation is attained for one hour.	calculated bas	ed on the m	easured watts, assuming the service level is				
Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	Sound Power (L <sub>WAd</sub> , bels)			Sound Pressure (L <sub>pAm</sub> , decibels)				
Typically Configured — Idle	2.8		18					
Fixed Disk – Random writes	2.8	2.8 19		19				
Batteries	This battery(s) in this product comply with EU Directive 2006/66/EC			2006/66/EC				
	Batteries used in the produ Mercury greater the1p Cadmium greater than							
	Battery size: CR2032 (coin Battery type: Lithium	cell)						



Additional Information	<ul> <li>This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.</li> <li>This HP product is designed to comply with the Waste Electrical and Electronic Equipm (WEEE) Directive - 2002/96/EC.</li> <li>This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).</li> <li>This product is in compliance with the IEEE 1680 (EPEAT) standard at the <gold> level www.epeat.net</gold></li> <li>Plastics parts weighing over 25 grams used in the product are marked per ISO11469 at ISO1043.</li> <li>This product contains 0% post-consumer recycled plastic (by wt.)</li> <li>This product is 94.6% recycle-able when properly disposed of at end of life.</li> </ul>				
Packaging Materials	External:	PAPER/Corrugated	326 g		
	Internal:	PLASTIC/Polyethylene Expanded - EPE	42 g		
		PLASTIC/Polyethylene low density - LDPE	15 g		
		PLASTIC/Polypropylene - PP	4 g		
	The plastic p	packaging material contains at least 50% recycled content	_		
Material Usage	The corruga	ted paper packaging materials contains at least 70% recy	cled content.		
	<ul> <li>Asbe</li> <li>Cert</li> <li>Cadi</li> <li>Chlo</li> <li>Chlo</li> <li>Forr</li> <li>Halo</li> <li>Lead</li> <li>Mero</li> <li>Nick</li> <li>hano</li> <li>Ozoi</li> <li>Poly</li> <li>Poly</li> <li>Poly</li> <li>Poly</li> <li>Poly</li> <li>beei</li> <li>Radi</li> </ul>	HP General Specification for hp.com/hpinfo/qlobalcitizenship/environment/pdf/qse.pd	ame retardants in plastics igned to be frequently tain retail packaging has		



Packaging Usage	<ul> <li>HP follows these guidelines to decrease the environmental impact of product packaging:         <ul> <li>Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.</li> <li>Eliminate the use of ozone-depleting substances (ODS) in packaging materials.</li> <li>Design packaging materials for ease of disassembly.</li> <li>Maximize the use of post-consumer recycled content materials in packaging materials.</li> <li>Use readily recyclable packaging materials such as paper and corrugated materials.</li> <li>Reduce size and weight of packages to improve transportation fuel efficiency.</li> <li>Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.</li> </ul> </li> </ul>
End-of-life Management and Recycling	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <a href="http://www.hp.com/qo/reuse-recycle">http://www.hp.com/qo/reuse-recycle</a> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.  The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: <a href="http://www.hp.com/qo/recyclers">http://www.hp.com/qo/recyclers</a> .
	These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.
HP, Inc. Corporate Environmental	For more information about HP's commitment to the environment:
Information	Global Citizenship Report <a href="http://www.hp.com/hpinfo/qlobalcitizenship/qcreport/index.html">http://www.hp.com/hpinfo/qlobalcitizenship/qcreport/index.html</a> For table 1 and 1
	Eco-label certifications  http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates:
	http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842
	and
	http://www.hp.com/hpinfo/qlobalcitizenship/environment/pdf/cert.pdf



## **Technical Specifications**

#### HP ProBook 650 G3 Notebook PC

Eco-Label Certifications			certified to the following approvals and may be			
& declarations	labeled with one or more of these marks:					
	IT ECO declaration     IS ENERGY STARS					
		<ul> <li>US ENERGY STAR®</li> <li>EPEAT® Gold registered in the United States. See http://www.epeat.net for registration</li> </ul>				
System Configuration	status in your cou		n and Declared Noise Emissions data for the			
System Configuration		on a "Typically Configured N				
Energy Consumption (in accordance with US						
ENERGY STAR® test						
method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz			
Normal Operation	6.29 W	6.66 W	6.42 W			
(Short idle)						
Normal Operation (Long	3.92 W	4.36 W	4.12 W			
idle)						
Sleep	0.43 W	0.48 W	0.43 W			
Off	0.23 W	0.28 W	0.23 W			
	family. HP computers ma Environmental Protection does not offer ENERGY S	rked with the ENERGY STAR Agency (EPA) ENERGY STAR® FAR® compliant configuratio aturing a hard disk drive, a	compliant product if offered within the model © Logo are compliant with the applicable U.S. specifications for computers. If a model family ons, then energy efficiency data listed is for a high efficiency power supply, and a Microsoft			
Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz			
Normal Operation (Short idle)	22 BTU/hr	23 BTU/hr	22 BTU/hr			



Normal Operation (Long idle)	13 BTU/hr	15 BT	TU/hr	14 BTU/hr
Sleep	1 BTU/hr	2 BT	U/hr	1 BTU/hr
Off	1 BTU/hr	1 BT	J/hr	1 BTU/hr
	*NOTE: Heat dissipation attained for one hour.	is calculated ba	ased on the measured watts	, assuming the service level is
Declared Noise	Sound Pow	er	Sound	l Pressure
Emissions (in accordance with	(L <sub>WAd</sub> , bels	s)	(L <sub>pAm</sub> ,	decibels)
ISO 7779 and ISO 9296)				
Typically Configured — Idle	3.1	3.1 2		24
Fixed Disk – Random	3.3		26	
writes				
Batteries	This battery(s) in this product comply with EU Directive 2006/66/EC			
	Batteries used in the product do not contain:    Mercury greater the1ppm by weight    Cadmium greater than 20ppm by weight  Battery size: CR2032 (coin cell) Battery type: Lithium			
Additional Information	<ul> <li>This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.</li> <li>This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.</li> <li>This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).</li> <li>This product is in compliance with the IEEE 1680 (EPEAT) standard at the gold level, see www.epeat.net</li> <li>Plastics parts weighing over 25 grams used in the product are marked per IS011469 and IS01043.</li> <li>This product contains 8.5% post-consumer recycled plastic (by wt.)</li> <li>This product is 94.9% recycle-able when properly disposed of at end of life.</li> </ul>			
Packaging Materials	External: PAPER/Co	External: PAPER/Corrugated 329 g		329 g
		Expanded Polyet	•	41 g
	PLASTIC/	Polyethylene lov	v density - LDPE	13 g



PLASTIC/Polypropylene - PP	5 g				
The plastic packaging material contains at least 50% recycled co	ontent.				
The corrugated paper packaging materials contains at least 70% recycled content.					
This product does not contain any of the following substances in	excess of regula	ntory limits (refer to			
the HP General Specification for	the	<b>Environment at</b>			
http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/c	gse.pdf):				
<ul> <li>Cadmium</li> <li>Chlorinated Hydrocarbons</li> <li>Chlorinated Paraffins</li> <li>Formaldehyde</li> <li>Halogenated Diphenyl Methanes</li> <li>Lead carbonates and sulfates</li> <li>Lead and Lead compounds</li> <li>Mercuric Oxide Batteries</li> <li>Nickel – finishes must not be used on the external surface handled or carried by the user.</li> <li>Ozone Depleting Substances</li> <li>Polybrominated Biphenyls (PBBs)</li> <li>Polybrominated Biphenyl Ethers (PBBEs)</li> <li>Polychlorinated Biphenyl (PCB)</li> <li>Polychlorinated Terphenyls (PCT)</li> <li>Polychlorinated Terphenyls (PCT)</li> <li>Radioactive Substances</li> <li>Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide</li> </ul>	ce designed to be nd certain retail (	e frequently Dackaging has been			
<ul> <li>Eliminate the use of heavy metals such as lead, chromiu packaging materials.</li> <li>Eliminate the use of ozone-depleting substances (ODS) i</li> <li>Design packaging materials for ease of disassembly.</li> <li>Maximize the use of post-consumer recycled content materials recyclable packaging materials such as pape</li> <li>Reduce size and weight of packages to improve transport</li> </ul>	im, mercury and in packaging man aterials in packag er and corrugated rtation fuel effici	cadmium in rerials. ging materials. I materials. ency.			
	The corrugated paper packaging materials contains at least 70% This product does not contain any of the following substances in the HP General Specification for http://www.hp.com/hpinfo/qlobalcitizenship/environment/pdf/sizenship/environmental-sizenship/environmenta	The plastic packaging material contains at least 50% recycled content. The corrugated paper packaging materials contains at least 70% recycled contert. This product does not contain any of the following substances in excess of regulation the HP General Specification for the http://www.hp.com/hpinfo/qlobalcitizenship/environment/pdf/gse.pdf):  - Asbestos - Certain Azo Colorants - Certain Brominated Flame Retardants – may not be used as flame retard Cadmium - Chlorinated Hydrocarbons - Chlorinated Paraffins - Formaldehyde - Halogenated Diphenyl Methanes - Lead carbonates and sulfates - Lead and Lead compounds - Mercuric Oxide Batteries - Nickel – finishes must not be used on the external surface designed to be handled or carried by the user Ozone Depleting Substances - Polybrominated Biphenyls (PBBs) - Polybrominated Biphenyl Ethers (PBBEs) - Polybrominated Biphenyl (PCB) - Polychlorinated Terphenyls (PCT) - Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail produntarily removed from most applications Radioactive Substances - Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)  HP follows these guidelines to decrease the environmental impact of product pace Eliminate the use of heavy metals such as lead, chromium, mercury and a packaging materials Eliminate the use of ozone-depleting substances (ODS) in packaging materials for ease of disassembly Design packaging materials for ease of disassembly Maximize the use of post-consumer recycled content materials in packaging			



## **Technical Specifications**

End-of-life	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic			
Management and	areas. To recycle your product, please go to: <a href="http://www.hp.com/qo/reuse-recycle">http://www.hp.com/qo/reuse-recycle</a> or contact your			
Recycling	nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.			
	The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: <a href="http://www.hp.com/qo/recyclers">http://www.hp.com/qo/recyclers</a> . These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.			
HP, Inc. Corporate	For more information about HP's commitment to the environment:			
Environmental Information	Global Citizenship Report  http://www.hp.com/hpinfo/qlobalcitizenship/qcreport/index.html  Eco-label certifications  http://www8.hp.com/us/en/hp-information/environment/ecolabels.html  ISO 14001 certificates:			
	http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842			
	and			
	http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf			

#### **COUNTRY OF ORIGIN**

TBD



## Options and Accessories (Sold separately and availability may vary by country.)

Category	Description	Part Number
Cases	HP Business Backpack	H5M90AA
	HP Business 4 Wheel Roller Case	H5M93AA
Docking	HP 3001pr USB 3.0 Port Replicator	F3S42AA
	HP USB-C Travel Dock	TOK29AA#ABA
	HP USB Travel Dock	TOK30AA#ABA
	HP Ultraslim Docking Station	D9Y32AA#xxx
Input Device	HP Comfort Grip Wireless Mouse	H2L63AA
	HP 3-Button USB Laser Mouse	H4B81AA
	HP Ultra Mobile Wireless Mouse	H6F25AA#xxx
	HP Slim Bluetooth Mouse	F3J92AA#xxx
	HP Ultrathin Wireless Mouse	L9V78AA
	HP Stereo USB Headset	T1A67AA
Adapters	DisplayPort to HDMI Adapter	F3W43AA
	DisplayPort to DVI Adapter	F7W96AA
Power	HP 45W Smart AC Adapter (4.5mm)	H6Y88AA#xxx
	45W 2 Prong Power Adapter, 4.5mm	L6F60AA#ABJ
	HP 65W Smart AC Adapter	H6Y89AA#xxx
	HP Notebook Power Bank	N9F71AA
	HP USB External DVDRW Drive	F2B56AA
Security	HP Keyed Cable Lock 10mm	T1A62AA
	HP Docking Station Cable Lock	AU656AA#XXX
Monitors	HP ProDisplay P240va 23.8-inch Monitor	N3H14AA
	HP ProDisplay P232 23-inch Monitor	K7X31AA



#### HP ProBook 640 G3 Notebook PC HP ProBook 650 G3 Notebook PC

# QuickSpecs

## Sumary of changes

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